Feynman Computing Center Projects & Upgrades

All Experimenters Meeting

Adam Walters May 23, 2011

Agenda

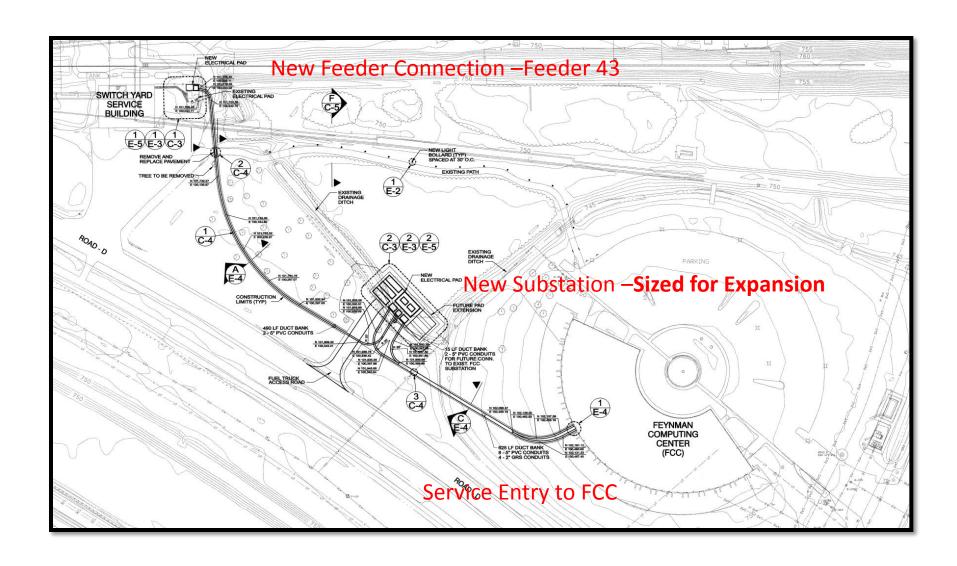
- Background
- High Availability Computing Center
- FCC Cooling Upgrades

Background

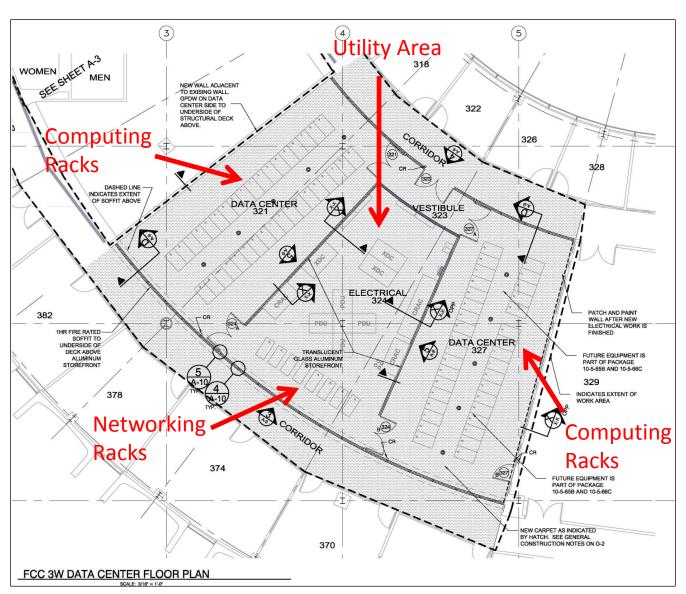
- Insufficient High Availability* computing space
 - Forecast out of capacity in late 2009
 - Electrical power at building entrance & UPS
 - Electrical distribution to computing racks
 - FCC cooling systems nearing end of life and full capacity
- ARRA* projects ramp up in 2009
 - Design in 2009
 - Construction phases in early 2010

^{*}American Recovery and Reinvestment Act (ARRA)

FCC Feeder Upgrade



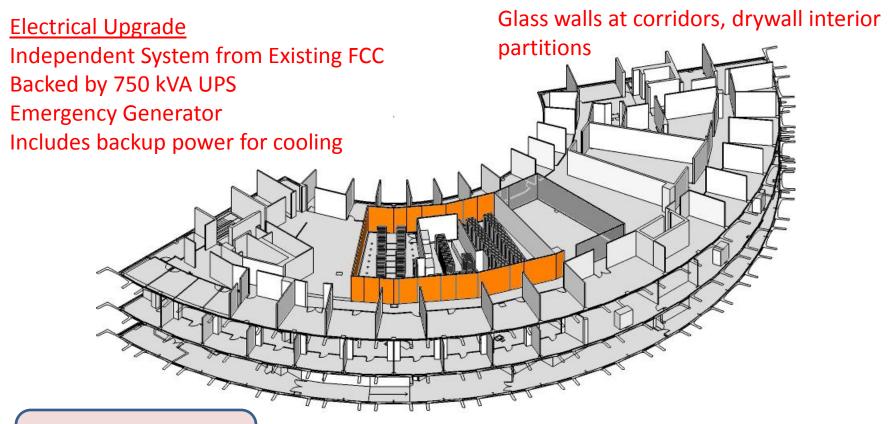
FCC3W Computer Room



From Project Statement:

"increase the electrical
capacity and associated
support functions for the
Feynman Computing Center
in order to support high
availability computing
operations"

HACC Data Center Outfitting



NTP Issued: Apr. 2010 Production: Jan. 2011

~72 47u racks, 6-7 kw/rack, 208V, accommodates dual cording

HACC Data Center Outfitting



FCC3 HACC North View



FCC3 HACC South View



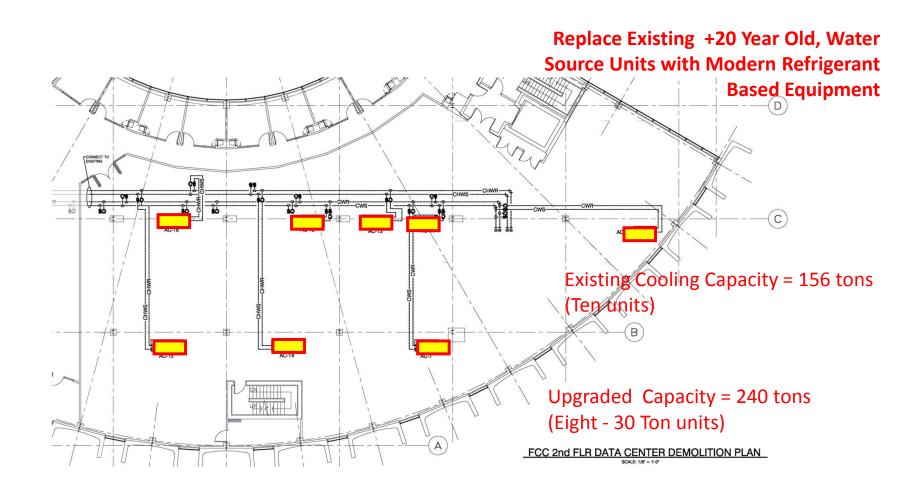
FCC2 Cooling Upgrade



From Project Statement: "provide modern computing room cooling equipment for the Feynman Computing Center in order to support program driven computing operations"

NTP Issued: Apr. 2010 Production: Aug. 2011

FCC2 Cooling Upgrade





FCC Roof Mods

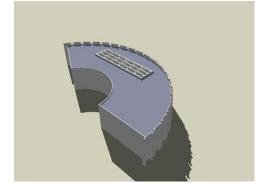




Reroofing of FCC

Structural Steel MechanicalPlatform for condensers for FCC2 and FCC3

Stair Extension from South Stairwell to Roof



Key Upgrade Benefits

To the Science Program and the Laboratory

- FCC3 High Availability Computer Room
 - Additional electric & cooling capacity
 - 72 racks; 750kVA UPS; high efficiency
- FCC2 Cooling Upgrades

- Thanks to FESS
 Engineering for
 excellent design work &
 construction oversight
- Removed SPOF (single point of failure) ICW cooling
- Replaced near end of life cooling systems
 - New cooling systems are higher efficiency
- More possibilities for redundancy planning of computing services
- Reduced FCC computer room footprint (sqft) while increasing power & cooling capacity